

Data sheet Product WLK 5

WLK 5



Thermal interface material / Fixing material / Mounting material>Thermal interface material>Thermally conductive adhesive
thermally conductive, electrically not conductive

WLK 10



Features

thermal conductivity:	0.836 W/m·K
specific thermal resistance:	1.2 m·K/W
hardening time:	20°C approx. 16-24h / 25°C approx. 8 h / 120°C approx. 20 min
volume resistance:	10 ¹⁶ Ω/cm
temperature range:	-56°C... +149°C
glue layer:	Epoxid
mixture proportion:	10:1
composition:	5 g resin/0.5 g hardener